

## IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF

TOSHIFUMI NAGAIWA, ET AL.

**: EXAMINER: 1763** 

SERIAL NO: 09/840,178

FILED: APRIL 24, 2001

: GROUP ART UNIT: KACKAR, R.

FOR:

WORKTABLE DEVICE AND

PLASMA PROCESSING

**APPARATUS FOR** 

SEMICONDUCTOR PROCESS

## <u>AMENDMENT</u>

ASSISTANT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231

SIR:

This is an amendment responsive to the Office Action dated June 20, 2002, please amend the above-identified application as follows:

## IN THE CLAIMS

Please cancel Claims 4, 8, 10, 11, 13 and 18 without prejudice.

1. (Amended) A worktable device for a semiconductor process, comprising:

a worktable having a main surface for supporting a target substrate and a sub-surface disposed around said main surface;

a cooms.

main surface and the sub-surface; a cooling mechanism disposed in said worktable and configured to supply cold to the

a focus ring placed on the sub-surface and configured to surround the target substrate

on the main surface; 7/27/20**02 | SEESHE1 | 00**00004**0 |**09840178

50:102

84.00 OP

TC 1700